

STKM2000 SERIES

2 μ/2 POLY/2 METAL BICMOS MIXED ANALOG-DIGITAL STANDARD CELLS

- ADVANCED BICMOS 2 $\mu/2$ POLY/ 2 METAL PROCESS
- TWIN TUB PROCESS
- HIGH LATCH-UP IMMUNITY
- POWER SUPPLY : MAXIMUM RATING : -0.5V TO 12V OPERATING CONDITIONS : 3V TO 10V
- MIXED ANALOG DIGITAL LIBRARY : ANALOG BIPOLAR LIBRARY ANALOG CMOS LIBRARY ANALOG BICMOS LIBRARY DIGITAL CMOS LIBRARY
- HIGH PROCESS PERFORMANCES: TRANSITION FREQUENCY, NPN = 6 GHz
 VERTICAL PNP = 2, 5 GHz
 DIGITAL CMOS OPERATING FREQUENCY : UP TO 30 MHz
- CAD SOFTWARE SUPPORT: FULLY INTEGRATED A.D.S. (ANALOG DE-SIGN SYSTEM) WITH ANALOG BLOCK GEN-ERATORS, SWITCHED CAPACITOR FILTER COMPILER; DIGITAL FUNCTIONS GENER-ATOR, RAM, ROM, PLA GENERATORS
- AVAILABILITY OF EEPROM DEVICES, ZENER DIODE, SCHOTTKY DIODE

- OPERATING TEMPERATURE RANGE: COMMERCIAL: 0 TO 70°C
 INDUSTRIAL: -40 TO 85°C
 MILITARY: -55 TO 125°C
- PACKAGE OPTIONS: DIL: PLASTIC OR CERAMIC SMD: SO, PLCC, QFP WAFER OR DIE

ASIC PRODUCTS DESCRIPTION

With the STKM2000 series, SGS-THOMSON Microelectronics introduces the "state of the art" product for analog signal processing, chain from sensor to actuator.

The introduction of new concepts (cells library and CAD) opens the design of analog functions and mixed analog and digital circuits with a safe and powerful approach. This new ASIC approach is the combination of innovative :

- BICMOS process
- Mixed libraries (ANALOG + DIGITAL)
- Generators and compilers
- "User friendly" CAD system
- Customer interface

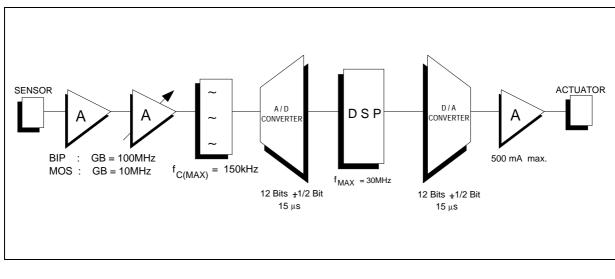


Figure 1 : The STKM2000 Series, a complete system solution

November 1989

STKM2000 ARCHITECTURE

Technology

The STKM2000 Series developed by SGS-THOMSON Microelectronics uses an advanced BICMOS silicon gate process with dual polysilicon layers and dual metal layers. This process is optimized to achieve high performance in digital CMOS applications. Depending on the operating supply voltage (10V, or 5V), the CMOS process behaves as an N-WELL technology (respectively with 2 μ gate length or 1.8 μ gate length) with operating speeds up to 30MHz. Thanks to the two metal layers, the digital part of the circuit can reach high gate density with low parasitic capacitances.

For analog functions, the STKM2000 series takes advantage of the bipolar structure:

- very high speed NPN transistor : f_T = 6 GHz
- very high speed vertical PNP : $f_T = 2.5 \text{ GHz}$

This allows high gain - bandwith operational amplifier (50 MHz), low noise input amplifier, short propagation delay comparator, ...

With the same BICMOS process, the analog CMOS performance come from the high density CMOS structure with a double poly layer for accurate capacitors, low consumption CMOS amplifier ($30 \mu A$), CMOS switches, high accuracy switched capacitor filters (up to 100 kHz for center frequency).

STKM2000 cell concepts

SGS-THOMSON Microelectronics has predesigned and precharacterized cells which are selected, placed and interconnected on the chip to implement digital and analog cells having different height and supply voltages. In addition some macrocells are designed as fixed blocks, so called "hard blocks" : filters, A/D and D/A converters; some hard blocks are automatically generated and parametrized from a compiler: S.C. filters, PLA, RAM, ROM...

STKM2000 chip topology

The chip is optimized versus the cell complexity, in a row based structure with different heights.

Peripheral cells surround the internal active chip area to interface with its external environment.

Despite the row based architecture, "hard blocks" can be implemented with efficient floor planning organization.

STKM2000 Cell libraries

SGS-THOMSON Microelectronics introduces the "programmable" library; instead of working with a finite number of cells of the library, the designer has now access to an infinite number of functions.

Defining only some properties, the designer is able to create himself the cells needed for his application. For example, the following electrical parameters are accessible and adjustable:

- gain-bandwith product
- phase margins, frequency compensation
- output buffer current
- biasing currents
- resistor, capacitor fields
- current, source or sink
- adjustable Ron switch resistor
- supply voltage assignment

The analog library is operating in a large voltage range: 3V to 10V.

The basic analog library contains:

- 60 analog CMOS functions
- 25 analog BIPOLAR functions

From single transitor to 12 bits A to D converter (with autocalibration), each setup becomes possible.

The digital CMOS library uses the same flexibility with a complete set of basic digital functions (NAND, NOR, Flip-Flop, ...) and some cell generators:

• register, counter, logic comparator, ... More than 60 digital cells are available.



Figure 2: The STKM2000 Series, a complete system solution

ANALOG LIBRARY

NPN transistor Lateral PNP Substrate PNP Isolated PNP NPN input comparator PNP input comparator N input comparator P input comparator N-MOS transistor P-MOS transistor NPN high-speed amplifier N input CMOS Op-Amp P input CMOS Op-Amp Crystal oscillator RC oscillator Transconductance Power-on reset (with adjustable threshold and hysteresis) Analog multiplexer Voltage to current converter Voltage reference 8 bits, A/D and D/A converters 12 bits A/D and D/A converters

DIGITAL LIBRARY

AND, NAND, OR, NOR, inverter Exclusive OR, NOR D latch Input buffer (TTL/CMOS) Output buffer (TTL/CMOS) Shift register Binary counter Decimal counter Magnitude comparator



CAD SUPPORT: A.D.S. (Analog Design System) SGS-THOMSON Microelectronics has introduced a sophisticated CAD approach to reduce the development leadtime and to increase design flexibility and safety.

Programmable cells in the library are defined as:

- alternative cell or,
- adjustable cell or,
- telescopic cell or,
- parametrisable cell

Some specific parts of the design are automatically handled by an analog design manager, in order to:

- reduce capture errors
- make unexperienced designer's task easier
- improve schematics lisibility
- check electrical design rules (Analog or Digital)

The Analog Design manager takes into account:

- transconductance block generation
- automatic cell biasing
- unconnected pins and power down processing
- multipower supplies processing

Figure 3: Analog Design System (A.D.S.) flow

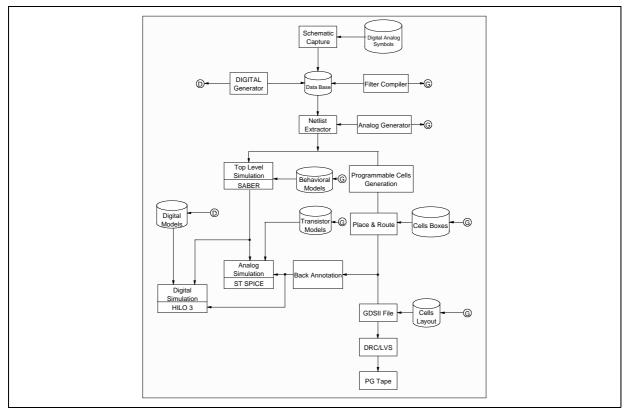
A major step has been made with the introduction of function generator and compiler approaches to improve design automation and design efficiency.

Operational amplifier generator

From a generic symbol and some properties, several parameters of the amplifier will be adjusted:

- Biasing current which controls major parameters of amplifier (gain-bandwidth, slew rate, power consumption).
- Frequency compensation which allows to adjust and optimize the dynamic parameters versus the capacitive and resistive load.
- Power down capabilities.
- Supply voltage of the cell.

A specific software manages all these properties and automatically updates all libraries included in the design flow: macro models and transistor level models, footprint, GDS2 layout, LVS netlist.



SGS-THOMSON

Filter compiler

From the template defined at the beginning up to the complete layout, the software handles automatically the filter synthesis and the layout compilation:

- evaluation/mathematical analysis
- switched capacitor synthesis
- simulation
- Monte-Carlo analysis
- layout generation

Any kind of filters is available from 2nd up to 12th order.

Digital cell generator

For a set of basic digital cells, the user has access to generators which handle the netlists and interface with the layout tools. The schematic capture uses a block which is programmable according to the required complexity.

The generator creates a "so-called" soft macrocell taking into account the complete netlist:

- counters
- shift registers
- magnitude comparators, ...

A part from the software automation, the A.D.S. CAD tool works around standard softwares.

The CAD approach is compatible with both approaches:

- VAX_{TM}/VMS operating system
- SUN_{TM}/UNIX operating system

	VAX _{TM}	SUN _{TM}
Schematic capture	CASS	EDGE
	(SILVAR LISCOтм)	(CADENCETM)
Logic simulation	HILO 3	MOZART
	(GENRAD _{TM})	(SGS-THOMSON)
Analog simulation	ST-SPICE	ST-SPICE
	(SGS-THOMSON)	(SGS-THOMSON)
Top level simulation	SABER	SABER
	(ANALOGY _{TM})	(ANALOGY _{TM})
Layout	CALMP	
	(SILVAR LISCO _{TM})	EDGE (CADENCE _{TM})
DRC - LVS	DRACULA	EDGE
	(CADENCE _{TM})	(CADENCE _{TM})



STKM2000 SERIES

Customer design interface

SGS-THOMSON Micorelectronics has developed several interfaces for customers giving them easy and flexible design approaches for STKM2000.

Users can access Analog Design System (A.D.S.):

- via SGS-THOMSON design centers
- via SGS-THOMSON associated design centers
- via CAE workstations

CAE worstation capabilities are under development on:

- Dazix System
- Mentor Graphics
- Sun

In that case, direct interfaces will be offered in order to make design implementation with A.D.S. (layout and test generations).

According to these design possibilities, SGS- THOMSON defines 3 main interfaces.

Figure 4 outlines these interfaces. Each interface details the responsibilities of customer and SGS-THOMSON during circuit development flow.

	Interface 2	Interface 3	Interface 4
Responsibility level	Breadboard schematics	Simulated schematics Layout tape	
Circuit definition	Ctm		
Schematics		Ctm	Ctm
Simulations	ST		
Layout		ST	
Final control	ST + Ctm	ST + Ctm	ST + Ctm
Prototyping phase	ST	ST	ST

Figure 4: SGS-THOMSON - CUSTOMER interfaces



MAXIMUM RATINGS

Symbol	Parameter	Min	Мах	Unit
V _{DD}	Supply voltage	- 0.5	12.0	V
V _I , V _O	I/O voltage	- 0.5	V _{DD} + 0.5	V
lı, lo	I/O current	- 40	+ 40	nA
T _{stg}	storage temp. (ceramic)	- 65	+ 150	°C
	storage temp. (plastic)	- 40	+ 125	°C

Note 1: Stresses above those under "maximum ratings" may cause permanent damage to the device. This is a stress rating only and functional operation for the device at these or any other

conditions above indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

RECOMMENDED DC OPERATING CONDITIONS

Voltage referred to V_{SS}

Symbol	Parameter	Min	Max	Unit
V _{DD}	Operating supply voltage	2.7	11	V
T _{amb}	Operating ambient temperature			
	Military	- 55	+ 125	°C
	Industrial	- 40	+ 85	°C
	Commercial	0	+ 70	°C

DIGITAL LIBRARY AC ELECTRICAL CHARACTERISTICS ABSTRACT

Standard condition = 2 loads + 1 mm of metal interconnect

Cell code	Description	V_{DD} = 10V \pm 10%, T = 25°C			Unit
Centode	Description	TPHL	TPLH	OTHER	Onic
IV1	Standard inverter	2.26	2.01		ns
ND2	2 - input NAND	1.74	2.44		ns
NR2	2 - input NOR	2.55	2.02		ns
FD1	D Flip - Flop				
	From C to QN	6.44	8.26		
	TSU			5.00	
	тн			1.75	ns
	тwн			8.25	
	TWL			5.00	
OB11	CMOS inverting output buffer				
	capacitance load = 100 pF	12.4	12.3		ns



DC GENERAL ELECTRICAL CHARACTERISTICS

 V_{DD} = 5V \pm 10% or V_{DD} = 10V \pm 10% (unless otherwise specified)

Symbol	Parameter	Condition	Min	Тур	Max	Unit
VIH	High level TTL input voltage	$V_{DD}=~5V\pm10\%$				
		$T^{o} = 0^{o}C / + 70^{o}C$	2.0			V
		$T^{o} = -40^{o}C / + 85^{o}C$	2.25			V
		$T^{o} = -55^{o}C / + 125^{o}C$	2.25			V
VIL	Low level TTL input voltage	$V_{DD}=~5V\pm10\%$			0.8	V
		all temp. ranges				V
VIH	High level CMOS input voltage		70%VDD			V
VIL	Low level CMOS input voltage				30%VDD	V
I _{OZH}	Tristate output leakage current	$V_{O} = V_{DD}$				
		$T^{o} = 0^{o}C / + 70^{o}C$			2.5	μA
		$T^{o} = -40^{o}C / + 85^{o}C$			5	μA
		$T^{o} = -55^{o}C / + 125^{o}C$			10	μA
lozl		$V_{O} = V_{SS}$				μA
		$T^{o} = 0^{o}C / + 70^{o}C$	- 2.5			μA
		$T^{o} = -40^{o}C / + 85^{o}C$	- 5.0			μA
		$T^{o} = -55^{o}C / + 125^{o}C$	- 10.0			μA
IIн	High level input leakage current	VO = V _{DD}				
		$T^{o} = 0^{o}C / + 70^{o}C$			1.0	μA
		$T^{o} = -40^{o}C / + 85^{o}C$			3.0	μA
		$T^{o} = -55^{o}C / + 125^{o}C$			5.0	μA
IIL	Low level input leakage current	VI = V _{SS}				
		$T^{o} = 0^{o}C / + 70^{o}C$	- 1.0			μA
		$T^{o} = -40^{o}C / + 85^{o}C$	- 3.0			μA
		$T^{o} = -55^{o}C / + 125^{o}C$	- 5.0			μA
lcc	Max admissible current per pin:					
	- analog				± 20	mA
	- digital				± 40	mA



Cell code	Description	Parameters	Min	Тур	Max	Unit
		Test conditions				
CMP11	Static CMOS	Propagation delay		1	1.4	ms
	comparator	(overdrive = 5 mV)				
		Offset		± 3	± 10	mV
CMP31	Static BICMOS	Propagation delay		90	110	ns
	comparator	(overdrive = 5 mV)				
		Offset		± 2	± 7	mV
CPX11	Capacitor fields	Unit capacitance		0.1		pF
		Capacitor value range	0.1		50	pF
		Absolute accuracy			± 15	%
		Matching (capacitor ratio)		0.5	1.0	%
CPP11	Monolithic Capacitor	Capacitor range	1		100	pF
		Absolute accuracy			± 15	%
RPM/PPM	Resistor/Potentiometer	Resistor value range	6.5		3000	KΩ
	P-Base	Absolute accuracy			± 20	%
		Matching			± 1	%
		Temperature coefficient			0.2	%
		Voltage coefficient			0.05	%
SWI1	Analog switch	Elementary switch RON value		5	25	KΩ
		Number of switches in parallel	1		3	
MN11	Telescopic NMOS	RON value		100		Ω
	transistor					
OPA31	General purpose	Unity gain bandwidth		3.3	4.6	MHz
	MOS Operational	Current consumption		700		μA
	amplifier	Phase margin				0
		$(C1 = 100 \text{ pF}, R2 = 10 \text{ k}\Omega)$		60		
		Offset		± 3	± 10	mV
OPA41	Internal bipolar	Unity gain-bandwidth		9	30	MHz
	Operational Amplifier	current consumption		240		μA
		Phase margin		62		0
		$(CL = 15 \text{ pF}, \text{RL} = 100 \text{k}\Omega)$				
		Offset		± 1	± 5	mV
OPA71	Rail to rail external	Unity gain bandwidth		2.3		MHz
	MOS operational	current consumption		360		uA
	Amplifier	Phase margin		80		0
		$(CL = 100 \text{ pF}, \text{RL} = 100 \text{K}\Omega)$				
		Offset		± 3	± 10	mV
OTA11	MOS	Unity gain - bandwidth		24		MHz
	transconductance	(CL = 2 pF)				
	amplifier					
POR11	Programmable Power	Active Level Accuracy			± 5	%
FURI	on Reset	Hysteresis Accuracy			± 5	%
VRF11	Voltage bandgap	Output voltage accuracy			± 2	%
	reference	Temperature coefficient			100	ppm
		Current consumption		15		μA

ANALOG LIBRARY AC ELECTRICAL CHARACTERISTICS ABSTRACT



Cell code	Description	Parameters	Min	Тур	Max	Unit
		Test conditions				
OSC11	Programmable crystal oscillator	Frequency	0.1		20	MHz
OSC41P	RC oscillator	Frequency	1	100	800	KHz
		Stability versus temperature		0.01		% / °C
		Stability versus voltage		0.5		% / V
OSC31P	One pad I.C oscillator	Frequency	2		200	KHz
		Stability versus temperature		0.01		%/°C
		Stability versus voltage		0.5		% / V
	Filters	Order	2		12	
		Center frequency			100	KHz
ADC81	8 bit analog to	Conversion time			5	μs
	digital converter	Integral non linearity			± 0.5	LSB
		Differential non linearity			± 0.5	LSB
DAC81	8 bit analog to	Conversion time			1	μs
	digital converter	(CL = 2 pF)				
		Integral non linearity			± 0.5	LSB

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